

Special Issue

Advanced Active and Passive Metasurfaces

Message from the Guest Editors

This Special Issue on “Advanced Active and Passive Metasurfaces” in the journal Applied Sciences is aimed to summarize the recent advances in the development of active and passive metasurfaces and their related applications in the different fields of physics and engineering. The scope includes theoretical, computational and experimental contributions ranging from fundamental research to new designs and ideas for the development of advanced and functional applications of the metasurface concept. Topics of interest include but are not limited to:

- metasurface
- antennas
- lenses
- OAM
- surface
- plasmons
- non-reciprocity
- holography

Guest Editors

Prof. Dr. Shah Nawaz Burokur
LEME, UPL, Université Paris Nanterre, F92410 Ville d'Avray, France
Prof. Dr. Oscar Quevedo-Teruel
KTH Royal Institute of Technology

Deadline for manuscript submissions

closed (31 December 2019)



Applied Sciences

an Open Access Journal
by MDPI

Impact Factor 2.5
CiteScore 5.5



mdpi.com/si/19268

Applied Sciences
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
appls@mdpi.com

[mdpi.com/journal/
appls](https://mdpi.com/journal/appls)





Applied Sciences

an Open Access Journal
by MDPI

Impact Factor 2.5
CiteScore 5.5



[mdpi.com/journal/
applsci](https://mdpi.com/journal/applsci)



About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo
Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32,
20133 Milano, Italy

Author Benefits

Open Access:

free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility:

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, Embase, CAPIus / SciFinder, and other databases.

Journal Rank:

JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)